

FDS6574A

20V N-Channel PowerTrench⁰ MOSFET

General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $R_{DS(ON)}$ and fast switching speed.

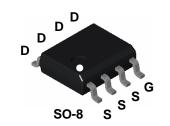
Applications

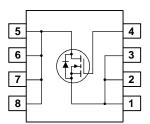
• DC/DC converter



Features

- Low gate charge
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability
- RoHS Compliant





Absolute Maximum Ratings T_A=25°C unless otherwise noted Ratings Symbol Parameter Units 20 V_{DSS} Drain-Source Voltage V V_{GSS} V Gate-Source Voltage ± 8 Drain Current – Continuous 16 А I_D (Note 1a) - Pulsed 80 P_D Power Dissipation for Single Operation (Note 1a) 2.5 w 1.2 (Note 1b) (Note 1c) 1.0 –55 to +175 T_J, T_{STG} Operating and Storage Junction Temperature Range °C Thermal Characteristics $R_{\theta JA}$ Thermal Resistance, Junction-to-Ambient (Note 1a) 50 °C/W Thermal Resistance, Junction-to-Case 25 °C/W $R_{\theta JC}$ (Note 1) **Package Marking and Ordering Information**

Device Marking	Device	Reel Size	Tape width	Quantity
FDS6574A	FDS6574A	13"	13" 12mm	

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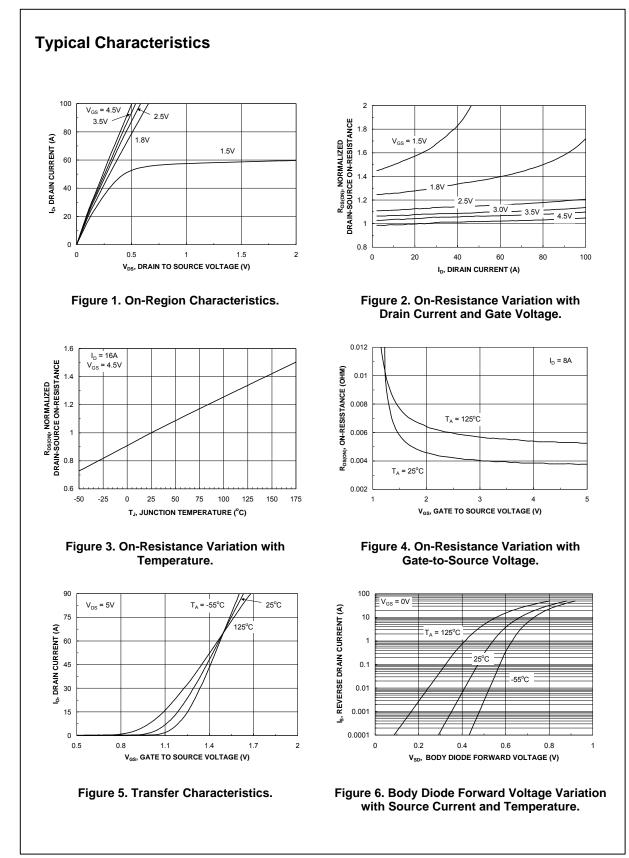
FDS6574A Rev B2(W)

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May 2008

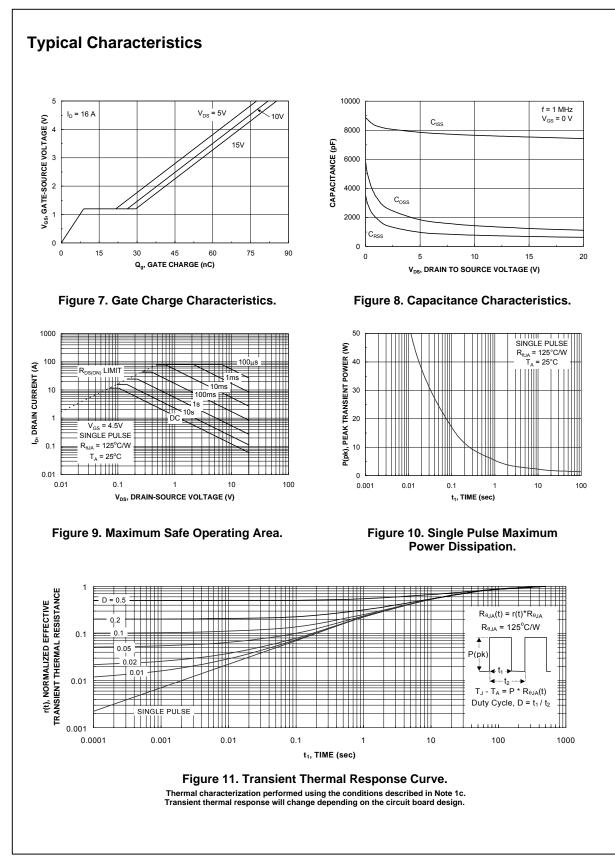
FDS6574A

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	racteristics					l
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = 250 \mu A$	20			V
<u>ΔBV_{DSS}</u> ΔTJ	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		10		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 16 V$, $V_{GS} = 0 V$			1	μA
I _{GSSF}	Gate–Body Leakage, Forward	V_{GS} = 8 V, V_{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage, Reverse	V _{GS} = -8 V V _{DS} = 0 V			-100	nA
On Cha	racteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, \qquad I_D = 250 \ \mu A$	0.4	0.6	1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		-2.7		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = 4.5 \ V, I_D = 16 \ A \\ V_{GS} = 2.5 \ V, I_D = 15 \ A \\ V_{GS} = 1.8 \ V, I_D = 13 \ A \\ V_{GS} = 4.5 \ V, I_D = 16 \ A, T_J = 125^\circ C \end{array} $		4 4.4 5 5.3	6 7 9 9	mΩ
I _{D(on)}	On–State Drain Current	$V_{GS} = 4.5 \text{ V}, V_{DS} = 5 \text{ V}$	40			Α
g _{FS}	Forward Transconductance	$V_{DS} = 5 V$, $I_{D} = 16 A$		115		S
Dynami	c Characteristics		•		•	
C _{iss}	Input Capacitance	$V_{DS} = 10V, V_{GS} = 0V,$		7657		pF
Coss	Output Capacitance	f = 1.0 MHz	<u> </u>	1432		pF
Crss	Reverse Transfer Capacitance	-		775		pF
Switchi	ng Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 10 V, I_D = 1 A,$		19.5	35	ns
t _r	Turn-On Rise Time	$V_{GS} = 4.5 V, R_{GEN} = 6 \Omega$		22	36	ns
t _{d(off)}	Turn–Off Delay Time	-		173	277	ns
t _f	Turn–Off Fall Time	-		82	131	ns
Q _g	Total Gate Charge	V _{DS} = 10 V, I _D = 16 A,	1	75	105	nC
Q _{gs}	Gate–Source Charge	$V_{GS} = 4.5 V$		9	100	nC
Q _{gd}	Gate–Drain Charge	-		17		nC
	ource Diode Characteristics	and Maximum Patings				
	Maximum Continuous Drain–Source		1		2.1	A
ls	Drain–Source Diode Forward					
	Brain obaroo Biodo i oritara	$V_{GS} = 0 V$, $I_S = 2.1 A$ (Note 2)		0.56	1.2	V



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